

AES-H610E1

IoT Edge Embedded System With Intel® 12th Gen Processors



Features

- Intel® 12th Gen Core™ Processors with H610 Chipset
- 2 x 260-pin DDR4 SO-DIMM up to 64GB (32GB per DIMM)
- 1 x PCIe x16 (PCIe Gen4)
- 1 x M.2 Key B, 1 x M.2 Key E, 2 x Mini PCIe
- 2 x USB 3.2 Gen2x1, 2 x USB 3.2 Gen1x1, 2 x USB 2.0, 6 x COM, 4 x SA TA3, 8 x DI, 8 x DO
- 4 x Intel 2.5G LAN (2 support PoE)
- 1 x Displayport, 1 x HDMI 2.0b, 1 x VGA
- Powerful Edge AI acceleration enabled by the most flexible mechanical, thermal, and power design, with support for 275mm x 124 mm x 60 mm (L x H x D) max. and up to 180W graphic card

Specification

System

CPU	Intel® 12th Gen Core™, Pentium or Celeron Processors
Chipset	Intel® H610
Socket	LGA 1700

Memory

Technology	Dual Channel DDR4 2933MHz
Capacity	64 GB (32 GB per DIMM)
Socket	2 x 260-pin SO-DIMM

Graphics

Controller	Intel® UHD Graphics
DisplayPort	DisplayPort 1.4a, DP++ Max resolution up to 4096x2160@60Hz
HDMI	HDMI 2.0b Max resolution up to 4096x2160@60Hz
VGA	Max resolution up to 1920x1200@60Hz

Expansion Slot

PCIe	1 x PCIe Gen4 x16*, PCIe x16 slot with default power cable can support up to 180W graphic card (275mm x 111.15 mm x 60 mm (L x H x D), if remove the card holder, it can be limited on 275mm x 124mm x 60 mm) Graphic card can be up to 255W with optional VGA module
Mini-PCIe	1 x Full/Half size with PCIe Gen3 x1 and USB 2.0 1 x Full/Half size with PCIe Gen3 x1
RF& Antenna	8 x SMA connector hole reserved
M.2	1 x M.2 (Key E, 2230) with CNVI/PCIe Gen3 x1 and USB2.0 for Wi-Fi/BT module 1 x M.2 (Key B, 2280/3042/3052) with PCIe Gen3 x1 / USB2.0 for 4G / 5G
SIM Socket	2 x Nano SIM Card slot (1 connected to Mini PCIe, 1 connected to M.2 Key B)

Audio

Interface	2 Realtek ALC897, High Definition Audio.
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Ethernet

Controller/ Speed	4 x Intel 2.5G LAN (2 support PoE, PoE output max. 15.4W/port, each port supports IEEE 802.3AF PoE)
Connector	4 x RJ45

Storage

SATA	4 x SATA3 (6Gb/s) 4 x 2.5" HDD/SSD Tray
CFast (Option)	1 x Type II socket (Shared with SATA3)

Rear I/O

DisplayPort	1
HDMI	1
VGA	1
Ethernet	4 x 2.5G LAN
USB	2 x USB 3.2 Gen2x1, 2 x USB 3.2 Gen1x1, 2 x USB 2.0, 1 x USB2.0 internal connector w/ lock function
Audio	1 x Mic-in, 1 x Line-out
COM	4 x RS232/422/485 2 x RS232
DIO	8 DI/8 DOs

Watchdog Timer

Output	From Super I/O to drag RESETCON#
Interval	256 Segments, 0, 1, 2, ...255sec

Power Requirements

Input PWR	V~36V VDC
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Environment

Operating Temp.	35W CPU: -40°C~75°C (-40°F~167°F) 46W~65W CPU: -40°C~55°C (-40°F~131°F) (with FAN inside, without Add-on Card) (w/ air flow 0.5~0.8 m/s)
Storage Temp.	-40°C~85°C (-40°F~185°F)
Humidity	~95% @ 40°C (non-condensing)
Shock	Operating: 50 G, half sine 11ms duration with SSD
Vibration	Operating: 5 Grms, 5-500 Hz, 3 axes with SSD
ESD	Contact +/-4kV, Air +/-8kV
EMC	EN61000-6-4/-2, CE & FCC Class A
Safety	LVD

Specification

Mechanical

Construction	Aluminum heatsink + Metal chassis
Mounting	Desk Mount
Dimensions	202mm (W) x 290mm (D) x 209.3mm (H) (7.95" x 11.42" x 8.24")
Net Weight	10kg

Others

OS Support	Windows 10 & Linux
TPM	TPM 2.0
Real-Time Enablement	TSN, TCC support under YOCTO

CPU List

CPU	"P-Core Basic GHz"	"E-Core Basic GHz"	Core	Thread	TDP (W)
i9-12900TE	1.10GHz	1.00GHz	16	24	35
i9-12900E	2.30GHz	1.70GHz	16	24	65
i7-12700TE	1.40GHz	1.00GHz	12	20	35
i7-12700E	2.10GHz	1.60GHz	12	20	65
i5-12500TE	1.9GHz	N/A	6	12	35
i5-12500E	2.9GHz	N/A	6	12	65
i3-12100TE	2.10GHz	N/A	4	8	35
i3-12100E	3.2GHz	N/A	4	8	65
G6900TE	2.40GHz	N/A	2	2	35
G6900E	3.00GHz	N/A	2	2	46